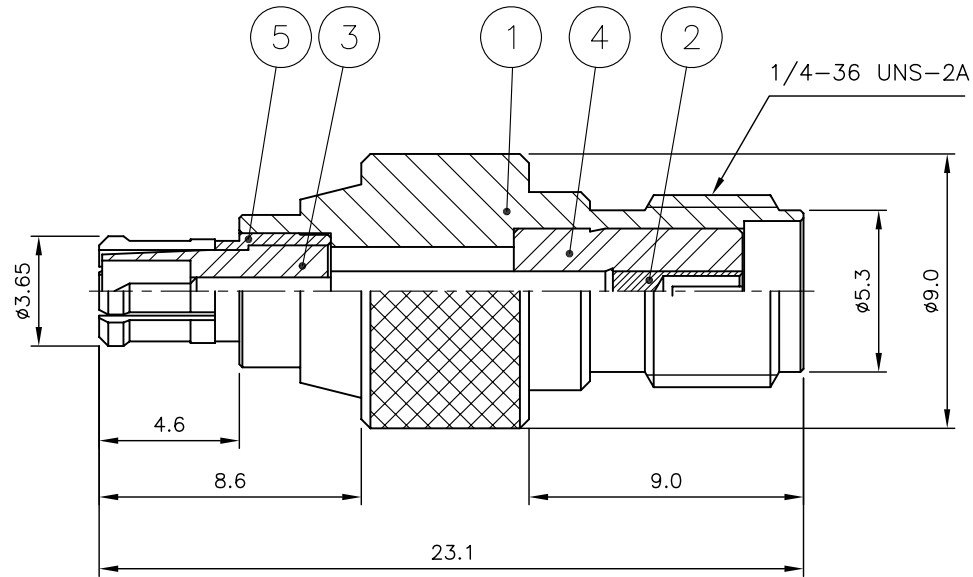


REVISION					
REV	DESCRIPTION	DRAWN	APPR	DATE	
IR	Initial Registration			2000.08.04.	
1	[설번처리No.201303-0006] 조립성 개선(BODY 낙시바늘 추가, TEF 변경)	E.H.KIM	I.C.KIM	2013.03.12.	



5	JACK	1	BeCu	Gold Plated	DJA00009-5/1
4	INSULATOR	1	TEFLON		DIN00090-N/1 DIN00189-N/1
3	INSULATOR	1	TEFLON		DIN00062-N/1
2	CONTACT	1	BeCu	Gold Plated	DAC00003-5/1
1	BODY	1	MBsBD	Gold Plated	DBD00291-5/2 DBD00291-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2013. 03. 12.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017		
	Angle	APPROVED BY	I.C.KIM				
	$\pm 1^{\circ}$	CHECKED BY					
MATERIAL	_____	DRAWN BY	E.H.KIM		TITLE	MCX50 (P) SMA50 (J) ADAPTOR	
FINISH	_____	SCALE	UNIT		A4	DWG NO.	AD00155-7/2
		4/1	mm			REVISION	1